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Substitute for form 1449/PTO				<b>Complete if Known</b>	
				Application Number	10/589,399-Conf. #7126
				Filing Date	August 14, 2006
				First Named Inventor	Guo-Quan LU
				Art Unit	1793
				Examiner Name	Y. Takeuchi
(Use as many sheets as necessary)					
Sheet	1	of	2	Attorney Docket Number	
124617.0118					

## U.S. PATENT DOCUMENTS

## **FOREIGN PATENT DOCUMENTS**

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<b>NON PATENT LITERATURE DOCUMENTS</b>					
Examiner Initials	Cite No. <sup>1</sup>	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.			<sup>T<sup>2</sup></sup>
	J	Wong Wai Kwan et al. "Low temperature sintering process for deposition of nano-structured metal for nano IC packaging". ELECTRONICS PACKAGING TECHNOLOGY, 2003 pp. 551-556.			
	K	Zhang Zhiye et al. "Nanoscale silver sintering for high-temperature packaging of semiconductor devices". MATERIALS PROCESSING AND MANUFACTURING DIVISION. 2004, pp. 129-135.			
	L	Zhiye Zhang et al. "Pressure-Assisted Low-Temperature Sintering of Silver Paste as an Alternative Die-Attach Solution to Solder Reflow". IEEE TRANSACTIONS ON ELECTRONICS PACKAGING MANUFACTURING. VOL. 25, NO. 4, OCTOBER 2002 pp. 279-283.			

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